

MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model : MI0350ADT

For Customer's Acceptance:

| Customer | | |
|----------|--|--|
| Approved | | |
| Comment | | |

| Revision | 1.3 |
|---------------|------------|
| Engineering | |
| Date | 2013-06-04 |
| Our Reference | |



REVISION RECORD

| REV NO. | REV DATE | CONTENTS | REMARKS |
|---------|------------|------------------------------------|---------|
| 1.0 | 2012-02-23 | First release | |
| 1.1 | 2012-10-17 | Update external dimensions | |
| 1.2 | 2012-10-23 | Add gray scale inversion direction | |
| 1.3 | 2013-06-04 | Update LED life time | |
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GENERAL INFORMATION

| Item | Contents | Unit |
|---------------------------------------|--|-----------------|
| LCD type | TFT/Transmissive | / |
| Size | 3.5 | Inch |
| Viewing direction | 12:00 | O'Clock |
| Gray scale inversion direction | 6:00 | O'Clock |
| Module area ($W \times H \times T$) | 76.9×63.9×4.3 | mm ³ |
| Active area (W×H) | 70.08×52.56 | mm ² |
| Number of dots | 320(RGB)×240 | / |
| Driver IC | SSD2119 | / |
| Interface type | 8/9/16/18-bit 6800-series/8080-series Parallel Interface Serial Peripheral Inerface(SPI) 18-/16-bit RGB interface(OE,DOTCLK, HSYNC,VSYNC,DB[17:0]) VSYNC interface(system interface+VSYNC) WSYNC interface(system interface+ WSYNC) | / |
| Pixel arrangement | RGB vertical stripe | / |
| Input voltage | 3.3 | V |
| Backlight type | 6 LEDs | / |
| Colors | 262K | / |
| With/Without TSP | With T/P | / |
| Weight | TBD | g |

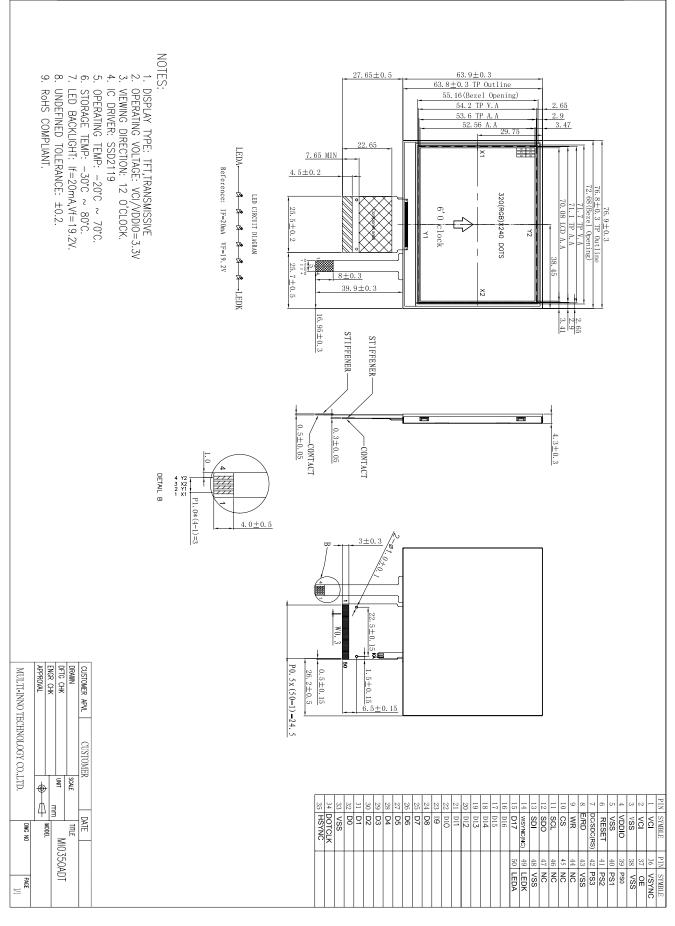
Note 1: Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2 : RoHS compliant;

Note 3: LCM weight tolerance: \pm 5%.



EXTERNAL DIMENSIONS





■ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Min | Max | Unit |
|-------------------------|-------------------|------|------------------|------|
| Supply voltage | V _{CI} | -0.3 | 4.0 | V |
| Input voltage for logic | V _{DDIO} | -0.5 | VCC+0.3 | V |
| Supply current(One LED) | ILED | - | 30 | mA |
| Operatingtemperature | Тор | -20 | 70 | °C |
| Storagetemperature | TST | -30 | 80 | °C |
| Humidity | RH | - | 90%(Max60 °C) | RH |

ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

| Parameter | Symbol | Min | Тур | Max | Unit |
|----------------------------------|------------------|--------|--------|--------|------|
| Supply voltage for logic | VCI | 2.5 | 3.3 | 3.6 | V |
| Inputvoltage'H'level | VIH | 0.8VCI | _ | VCI | V |
| Inputvoltage'L'level | VIL | -0.3 | _ | 0.2VCI | V |
| Input leakage current | ILKG | - | - | - | μA |
| LED forward voltage | Vf | 3.0 | 3.2 | 3.4 | V |
| Input backlight current(one LED) | I _{LED} | - | 20 | 25 | mA |
| LED life time | - | 30,000 | 50,000 | - | Hr |

TOUCH PANEL SPECIFICATIONS

ELECTRICAL CHARACTERISTICS

| ITEM | SPECIFICATIONS | | | | REMARK | | |
|-----------------------|-------------------------|---|-----|--------|--------------------------|--|--|
| | ITEM MIN. TYP. MAX UNIT | | | KLMARK | | | |
| Linearity | -1.5 | _ | 1.5 | % | After environment & life | | |
| Linearity | 1.0 | | 1.0 | /0 | test | | |
| Terminal Resistance | 200 | _ | 650 | ohm | X(Film side) | | |
| | 350 | _ | 800 | ohm | Y(Glass side) | | |
| Insulation Resistance | 10 | _ | - | Mohm | DC 25V 1min | | |
| Operating Voltage | - | 5 | _ | V | DC | | |

OPTICAL CHARACTERISTICS

| ITEM | SPECIFICATIONS | | | UNIT | REMARK | |
|--------------------|----------------|------|-----|------|-----------------|--|
| | MIN. | TYP. | MAX | | KEMAKK | |
| Response Time | _ | - | 10 | ms | 100kohm pull-up | |
| Light Transparency | 80 | _ | _ | % | | |



MECHANICAL CHARACTERISTICS

| ITEM | SPI | ECIFICATIO | ONS | UNIT | REMARK | |
|--------------------|-----------|------------|-----|-------|--------|--|
| | MIN. | TYP. | MAX | | KEMAKK | |
| Operation Force | _ | 20 | 50 | gf | Note1 | |
| Surface Hardness | 3 | _ | _ | Н | | |
| Pen Sliding | 100,000 | | | times | Note2 | |
| Durability | | | | | | |
| Hitting Durability | 1,000,000 | | | times | Note3 | |

Note 1: Do not operate it with a thing except a polyacetal pen (tip RO.8mm or less) or a finger, especially those with hard or sharp tips such as a ball point pen or a mechanical pencil.

Depending on the pitch & the dimension of the spacer dots in between. Note 2: Measurement for surface area.

-Scratch 100,000 times straight line on the film with a stylus change every 20,000 times.

-Force: 100gf.

-Speed: 60mm/sec.

-Stylus: R0.8 polyacetal tip.

Note 3: Hit 1,000,000 times on the film with an R12.5mm tip.

-Force: 250gf.

-Speed: 2 times/sec.

| Item | Symbol | Condition | Min | Тур | Max | Unit | Remark | Note |
|-------------------------|---------|---------------------------|-----|-------|-----|-------------------|---------------|------|
| Response time | Tr +Tf | | - | 25 | 35 | ms | Fig.1 | 4 |
| Contrastratio | Cr | θ=0° | 320 | 400 | - | | FIG 2. | 1 |
| Luminance uniformity | δ WHITE | Ø=0° Ta=25℃ | 80 | 85 | - | % | FIG 2. | 3 |
| Surface Luminance | Lv | 1a-23 C | - | 280 | - | cd/m ² | FIG 2. | 2 |
| | | Ø = 90° | 25 | 40 | - | deg | FIG 3. | |
| Viewing angle range | θ | $\emptyset = 270^{\circ}$ | 45 | 60 | - | deg | FIG 3. | 6 |
| viewing angle l'ange | | $\emptyset = 0^{\circ}$ | 45 | 60 | - | deg | FIG 3. | 0 |
| | | Ø = 180° | 45 | 60 | - | deg | FIG 3. | |
| | Red x | | - | 0.633 | - | | | |
| | Red y | | - | 0.329 | - | | | |
| | Green x | θ=0° | - | 0.297 | - | | | |
| CIE (x, y) chromaticity | Green y | | - | 0.577 | - | | FIG 2. | 5 |
| | Blue x | Ø=0° | - | 0.133 | - | | 110 2. | 5 |
| | Blue y | Ta=25℃ | - | 0.129 | - | | | |
| | White x | | - | 0.294 | - | | | |
| | White y | | - | 0.334 | - | | | |

ELECTRO-OPTICAL CHARACTERISTICS

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.:

Contrast Ratio = $\frac{\text{Average Surface Luminance with all white pixels (P_1, P_2, P_3, P_4, P_5)}{\frac{1}{2}}$

Average Surface Luminance with all black pixels $(\mathbf{P_1}, \mathbf{P_2}, \mathbf{P_3}, \mathbf{P_4}, \mathbf{P_5})$

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels (P₁, P₂, P₃, P₄, P₅)

Note 3. The uniformity in surface luminance , δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

 $\delta \text{ WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}{\text{Maximum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}$

Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series

Note 5. CIE (x, y) chromaticity, The x, y value is determined by measuring luminance at each test position 1 through 5, and then make average value

Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity,CIE The test data is base on TOPCON's BM-5 photo detector.

Note 8. For TFT module, Gray scale reverse occurs in the direction of panel viewing angle.

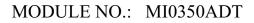


FIG.1. The definition of Response Time

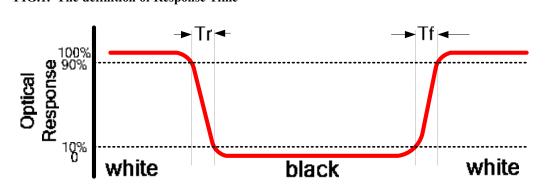


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity

A : 5 mm B : 5 mm H,V : Active Area Light spot size \emptyset =5mm, 500mm distance from the LCD surface to detector lens measurement instrument is TOPCON's luminance meter BM-5

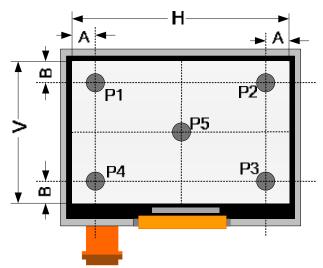
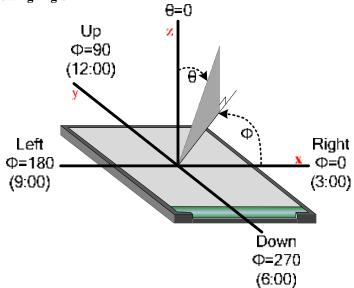


FIG.3. The definition of viewing angle







■ INTERFACE DESCRIPTION

| Pin No. | Symbol | Description |
|---------------|-----------------------|--|
| 1~2 | VCI | Booster input voltage pin |
| 3 | VSS | Ground. |
| 4 | VDDIO | Voltage input pin for logic I/O |
| 6 | RESB | System reset pin. - An active low pulse at this pin will reset the IC, Connect to VDDIO in normal operation |
| 7 | DC/SDC | A register select signal. Low: select an index or status register, High: select a control register. DC : Parallel Interface SDC : Serial Interface |
| 8 | E/ RD | 6800-system : E (enable signal) 8080-system : RD (read strobe signal) Serial mode : Not used and should be connected to VDDIO or Vss |
| 9 | WR (WR) | 6800-system : RW (indicates read cycle when High, write cycle when Low) 8080-system : WR (write strobe signal) |
| 10 | CS (SCS) | <pre>CS : Chip select pin for 6800/8080 Parallel Interface SCS : Chip Select pin for Serial Mode Interface</pre> |
| 11 | SCL | Serial clock input |
| 12 | SDO | Data output pin in serial interface |
| 13 | SDI | Data input pin in serial interface |
| 14 | WSYNC | Ram Write Synchronization output -Leave it OPEN when not used |
| $15^{\sim}32$ | DB17 [~] DB0 | Data bus. |
| 33 | VSS | Ground. |
| 34 | DOTCLK | Dot-clock signal and oscillator source. |
| 35 | HSYNC | Line Synchronization input |
| 36 | VSYNC | Frame/Ram Write Synchronization input |
| 37 | OE | Display enable pin from controller. |



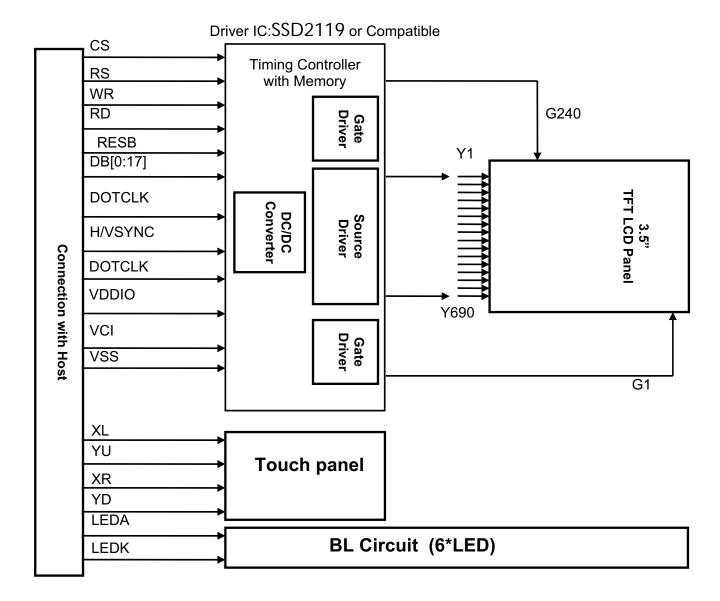
| 38 | VSS | Ground. | |
|-------|------|---------------------------|--|
| 39 | PS0 | | |
| 40 | PS1 | Refer of Table1 | |
| 41 | PS2 | | |
| 42 | PS3 | | |
| 43 | VSS | Ground. | |
| 44~47 | NC | Not Connection | |
| 48 | VSS | Ground. | |
| 49 | LEDK | Cathode of LED backlight. | |
| 50 | LEDA | Anode of LED backlight. | |

Table1

| PS3 | PS2 | PS1 | PS0 | Interface Mode | | |
|-----|-----|-----|-----|---|--|--|
| 0 | 0 | 0 | 0 | 16-bit 6800 parallel interface | | |
| 0 | 0 | 0 | 1 | 8-bit 6800 parallel interface | | |
| 0 | 0 | 1 | 0 | 16-bit 8080 parallel interface | | |
| 0 | 0 | 1 | 1 | 8-bit 8080 parallel interface | | |
| 0 | 1 | 0 | 0 | 9-bit generic D[17:9] (262k colour) + 3-wire SPI If 65K color, D12 shorts to D17 internally | | |
| 0 | 1 | 0 | 1 | 16-bit generic (262k colour)+ 3-wire SPI | | |
| 0 | 1 | 1 | 0 | 18-bit generic (262k colour)+ 3-wire SPI | | |
| 0 | 1 | 1 | 1 | 6-bit generic D[17:12] (262k colour) + 3-wire SPI | | |
| 1 | 0 | 0 | 0 | 18-bits 6800 parallel interface | | |
| 1 | 0 | 0 | 1 | 9-bits 6800 parallel interface | | |
| 1 | 0 | 1 | 0 | 18-bit 8080 parallel interface | | |
| 1 | 0 | 1 | 1 | 9-bit 8080 parallel interface | | |
| 1 | 1 | 1 | 0 | 3-wire SPI | | |
| 1 | 1 | 1 | 1 | 4-wire SPI | | |

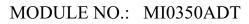


BLOCK DIAGRAM



■ APPLICATION CIRCUIT

Please consult our technical department for detail information.







■ RELIABILITY TEST

| No. | Test Item | Test Condition | Inspection after test | | |
|-----|----------------------------|--|--|--|--|
| 1 | High Temperature Storage | $70\pm2^{\circ}C/120$ hours | 1. Functional test is OK. | | |
| 2 | Low Temperature Storage | -20 ± 2 °C/120hours | Missing Segment, short, unclear segment, non- display, display abnormally and liquid crystal leak are | | |
| 3 | High Temperature Operating | 60 ± 2 °C/120hours | | | |
| 4 | Low Temperature Operating | -10 ± 2 °C/120hours | | | |
| 5 | Temperature Cycle | $-20\pm2^{\circ}C\sim25\sim70\pm2^{\circ}C\times10$ cycles | un-allowed. | | |
| 5 | | (30min.) (5min.) (30min.) | 2. No low temperature | | |
| 6 | Damp Proof Test | $40^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%$ RH/120hours | bubbles, end seal loose and fall, frame rainbow. | | |
| | | Frequency: 10Hz~55Hz Amplitude: 1.0mm, | Function test is OK. No glass crack, chipped | | |
| 7 | Vibration Test | Each direction on X,Y axe 0.5 houre, circle 2 hours | glass, end seal loose and fall, epoxy frame crack | | |
| 8 | Dropping test | Drop to the ground from 80cm height, one time, every side of carton. | 3. No structure loose and fall. | | |



■ INSPECTION CRITERION

| M | OUTGOING QUALITY STANDARD | PAGE 1 OF 4 |
|-------------|----------------------------------|-------------|
| TITLE:FUNCT | IONAL TEST & INSPECTION CRITERIA | MDS Product |

This specification is made to be used as the standard acceptance/rejection criteria for Color mobile phone LCM.

1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

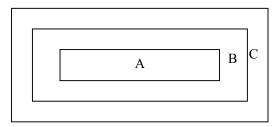
Major defect: AQL 0.65

Minor defect: AQL 1.5

2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line.

3. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.



| M | | OUTGOING QUALITY | STANDARD | | PAGE | 2 OF 4 |
|----------------------------------|--|--|---------------------------|--|---------|------------------------------|
| ITLE:F | UNCTIONAL | TEST & INSPECTION | CRITERIA | | MDS | Product |
| . Inspe | ction standa | rds | | | | |
| 4.1 Ma | jor Defect | | | | | |
| Item No | Items to be inspected |] | Inspection Standard | | | Classification of defects |
| 4.1.1 | All functional defects | No display Display abnormally Missing vertical, h Short circuit Back-light no lighting | | | | |
| 4.1.2 | Missing Missing component | | | | | Major |
| 4.1.3 | Outline dimension | Overall outline dimens | | | | |
| 4.2 Cos | smetic Defect | | | | | |
| Item Items to be No inspected | | | Classification of defects | | | |
| | Clear Spots For dark/white spot, sizeΦis defined $as \Phi = \frac{(x+y)}{2}$ | | | | | |
| | Black and white Spot defect | 1. Zone Size(mm) | | | ty C | Minor |
| | Pinhole, Foreign Particle, | Ф≤0.10 | Igno | | | |
| | Dirt under | 0.10<Φ≤0.15 | 2 | | Ignore | |

| | potarizer | 0.15≤Φ≤0.20 | | 1 | Ignore | | |
|-------|----------------------|-------------|-----|---------------|--------|---|---------|
| 4.2.1 | | Φ>0.20 | | 0 | | | |
| | Dim Spots | 2. | · | | | · | |
| | Circle | 2. Zone | | Acceptable Qt | у | | |
| | shaped and dim edged | Size(mm) | А | В | С | | |
| | defects | Ф≤0.2 | Igr | nore | | | Minor |
| | | 0.20≤Φ≤0.40 | | 3 | Ignana | | 1111101 |
| | | 0.40<Φ≤0.60 | | 2 | Ignore | | |
| | | 0.60<Φ≤0.80 | | 1 | | | |
| | | 0.80<Φ | | 0 | | | |
| L | 11 | | | | J | | |

Ignore

polarizer



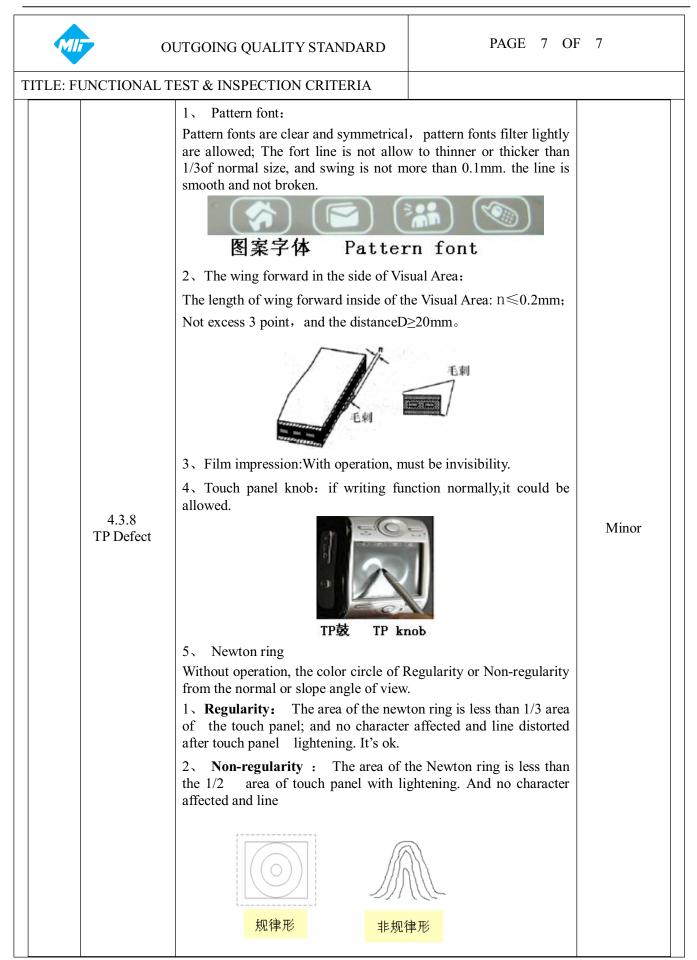
| TLE: F | FUNCTIONAL 7 | EST & INSPECT | ION CRITERIA | | | MDS | Prod | luct |
|------------|----------------------------|--|---|---|--|-----------------------------------|------|-------|
| .2. Co | smetic Defect | | | | | | | |
| Item No | Items to be inspected | | Inspection Standard | | | | | |
| | | Siz | ze(mm) | Ac | ceptable | Oty | ן ך | |
| | Line defect Black line, | | | | Zone | X - J | | |
| | | L(Length) | W(Width) | A | В | C | | |
| | White line, Foreign | Ignore | W≤0.02 | Ign | Ignore | | | |
| 4.2.2 | material under | L≤3.0 | 0.02 <w≤0.03< td=""><td>2</td><td>2</td><td></td><td>Min</td><td>Minor</td></w≤0.03<> | 2 | 2 | | Min | Minor |
| | polarizer, | L≤2.0 | 0.03 <w≤0.05< td=""><td>]</td><td>l</td><td>Ignore</td><td></td><td></td></w≤0.05<> |] | l | Ignore | | |
| | | | 0.05 <w< td=""><td>Define def</td><td>-</td><td></td><td></td><td></td></w<> | Define def | - | | | |
| | | | of 4.2.2. r scratch can be me special angle | | | | ng | |
| 4.2.3 | Polarizer scratch | condition or so | e(mm) | e, judge by | | lowing. | ng | Minor |
| 4.2.3 | | condition or so | r scratch can be me special angle e(mm) W(Width) | Acc | the fol eptable Zone B | lowing. | ng | Minor |
| 4.2.3 | | condition or so | e(mm) | e, judge by | the fol eptable Zone B | lowing. Qty | ng | Minor |
| 4.2.3 | | Condition or so Siz | r scratch can be me special angle e(mm) W(Width) | Acc A A Ignor | the fol eptable Zone B e | Qty C | ng | Minor |
| 4.2.3 | | condition or so Siz L(Length) Ignore | r scratch can be me special angle e(mm) W(Width) W≤0.03 | Acc A A Ignor 2 | the fol eptable Zone B e | lowing. Qty | ng | Minor |
| 4.2.3 | | condition or so Siz L(Length) Ignore 5.0 <l≤10.0< td=""></l≤10.0<> | r scratch can be me special angle e(mm) W(Width) W≤0.03 0.03 <w≤0.05< td=""><td>Acc A A Ignor 2</td><td>the fol eptable Zone B e</td><td>Qty C</td><td>ng</td><td>Minor</td></w≤0.05<> | Acc A A Ignor 2 | the fol eptable Zone B e | Qty C | ng | Minor |
| 4.2.3 | | condition or so Siz L(Length) Ignore $5.0 < L \le 10.0$ $L \le 5.0$ | $\frac{1}{10000000000000000000000000000000000$ | Acc A A Ignor 2 1 0 | the fol eptable Zone B e | Qty C | ng | Minor |
| 4.2.3 | | condition or so Siz L(Length) Ignore $5.0 < L \le 10.0$ $L \le 5.0$ | r scratch can be me special angle e(mm) W(Width) $W \le 0.03$ $0.03 < W \le 0.05$ $0.05 < W \le 0.08$ 0.08 < W tween glass & pole | Acc A A Ignor 2 1 0 | the fol eptable Zone B e I | Qty C | ng | Minor |
| 4.2.3 | scratch | condition or so Siz L(Length) Ignore $5.0 < L \le 10.0$ $L \le 5.0$ Air bubbles bet | r scratch can be me special angle e(mm) W(Width) $W \le 0.03$ $0.03 < W \le 0.05$ $0.05 < W \le 0.08$ 0.08 < W tween glass & pole | Acc A A Ignor 2 1 0 arizer | the fol eptable Zone B e I | Qty C | ng | Minor |
| 4.2.3 | | condition or so Siz L(Length) Ignore $5.0 < L \le 10.0$ $L \le 5.0$ Air bubbles bet 2. Zone | r scratch can be me special angle e(mm) W(Width) $W \le 0.03$ $0.03 < W \le 0.05$ $0.05 < W \le 0.08$ 0.08 < W tween glass & pole | Acc A A Ignor 2 1 0 arizer cceptable (B | the fol eptable Zone B e I | lowing. Qty C gnore | ng | Minor |
| | scratch | condition or so Siz L(Length) Ignore $5.0 < L \le 10.0$ $L \le 5.0$ Air bubbles bet 2. Zone Size(mm) | r scratch can be me special angle e(mm) W(Width) $W \le 0.03$ $0.03 < W \le 0.05$ $0.05 < W \le 0.08$ 0.08 < W ween glass & pole A A Igno | Acc A A Ignor 2 1 0 arizer cceptable (B | the fol eptable Zone B e I I | lowing. Qty C gnore C | ng | |
| | scratch | condition or so Siz L(Length) Ignore $5.0 < L \le 10.0$ $L \le 5.0$ Air bubbles bet 2. Zone Size(mm) $\Phi \le 0.2$ | r scratch can be me special angle e(mm) W(Width) $W \le 0.03$ $0.03 < W \le 0.05$ $0.05 < W \le 0.08$ 0.08 < W ween glass & pole A A Igno | Acc A A Ignor 2 1 0 arizer cceptable (B | the fol eptable Zone B e I I | lowing. Qty C gnore | ng | |

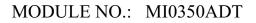


| M | OUTGOING QUALITY STANDARD PAGE 4 | | | | | |
|------------|----------------------------------|--|---------------------------|--|--|--|
| TITLE:FU | JNCTIONAL | TEST & INSPECTION CRITERIA MDS Pr | oduct | | | |
| 4.3. Cos | smetic Defect | | | | | |
| Item No | Items to be inspected | Inspection Standard | Classification of defects | | | |
| | | (i) Chips on corner $\begin{array}{c c} \hline & & & \\ \hline \\ \hline & & \\ \hline \\ \hline & & \\ \hline \hline \\ \hline \\ \hline \\ \hline \hline \\ \hline \\ \hline \hline \hline \\ \hline \hline \hline \\ \hline \hline \hline \\ \hline \hline \hline \hline \hline \hline \hline \\ \hline \hline$ | Minor | | | |
| 4.3.5 | Glass defect | (ii)Usual surface cracks $\begin{array}{c c} \hline X & Y & Z \\ \hline \leq 3.0 & < Inner border line of the seal & Disregard \\ \hline \end{array}$ | Minor | | | |
| | | (iii) Crack Cracks tend to break are not allowed. | Major | | | |
| 4.3.6 | Parts alignment | Not allow IC and FPC/heat-seal lead width is more than 50% beyond lead pattern. Not allow chip or solder component is off center more than 50% of the pad outline. | Minor | | | |
| 4.3.7 | SMT | According to the <acceptability assemblies="" electronic="" of=""> IPC-A-610C class 2 standard. Component missing or function defect are Major defect, the others are Minor defect.</acceptability> | | | | |



MODULE NO.: MI0350ADT





■ PRECAUTIONS FOR USING LCD MODULES

1 Handing Precautions

- 1.1 The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- 1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- 1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- 1.6 Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contact with oil and fats.

- 1.7 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 1.8 Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 1.9 Do not attempt to disassemble or process the LCD module.
- 1.10 NC terminal should be open. Do not connect anything.
- 1.11 If the logic circuit power is off, do not apply the input signals.
- 1.12 Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.

- Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

- To reduce the amount of static electricity generated, do not conduct assembling





and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.

- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

- Do not damage or modify the pattern writing on the printed circuit board.

- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.

- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

- Do not drop, bend or twist the LCM.

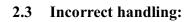


- 2 Handling precaution for LCM
 - 2.1 LCM is easy to be damaged. Please note below and be careful for handling.
 - 2.2 Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.





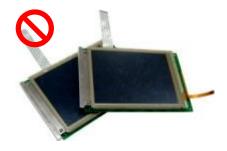
Please don't touch IC directly.



Please don't hold the surface of panel.



Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable.



Please don't operate with sharp stick such as pens.



3

Storage Precautions

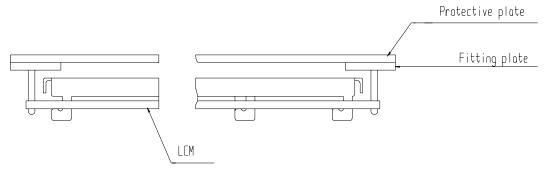
- 3.1 When storing the LCD modules, the following precaution are necessary.
 - 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
 - 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.
 - 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).
- 3.2 Others 其它
 - 3.2.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
 - 3.2.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
 - 3.2.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.2.3.1 Exposed area of the printed circuit board.
 - 3.2.3.2 -Terminal electrode sections.

4 USING LCD MODULES

4.1 Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

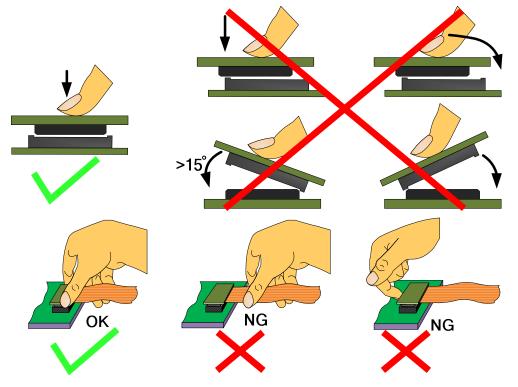
4.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



4.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.



4.2 Precaution for assemble the module with BTB connector: Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows



4.3 Precaution for soldering the LCM

| | Manual soldering | Machine drag soldering | Machine press soldering |
|---------|------------------|------------------------|-------------------------|
| No RoHS | 290°C ~350°C. | 330°C ~350°C. | 300°C ~330°C. |
| Product | Time : 3-5S. | Speed : 15-17 mm/s. | Time : 3-6S. |
| Tioduct | | | Press: 0.8~1.2Mpa |
| RoHS | 340°C ∼370°C. | 350°C ~370°C. | 330°C ~360°C. |
| Product | Time : 3-5S. | Speed : 15-17 mm/s. | Time : 3-6S. |
| TIOUUCI | | | Press: 0.8~1.2Mpa |

- 4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.
- 4.4 Precautions for Operation
 - 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
 - 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
 - 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
 - 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
 - 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
 - 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
 - 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.



4.6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

- 4.7 Return LCM under warranty
 - 4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :
 - 4.7.1.1 Broken LCD glass.
 - 4.7.1.2 PCB eyelet is damaged or modified.
 - 4.7.1.3 -PCB conductors damaged.
 - 4.7.1.4 Circuit modified in any way, including addition of components.

4.7.1.5 - PCB tampered with by grinding, engraving or painting varnish.

4.7.1.6 - Soldering to or modifying the bezel in any manner.

4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PACKING SPECIFICATION

Please consult our technical department for detail information.

PRIOR CONSULT MATTER

- 1 For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3 If you have special requirement about reliability condition, please let us know before you start the test on our samples.